MOSFET – N-Channel, POWERTRENCH[®]

80 V, 100 A, 4.2 m Ω

FDD86367

Features

- Typical $R_{DS(on)} = 3.3 \text{ m}\Omega$ at $V_{GS} = 10 \text{ V}$, $I_D = 80 \text{ A}$
- Typical $Q_{g(tot)} = 68 \text{ nC}$ at $V_{GS} = 10 \text{ V}$, $I_D = 80 \text{ A}$
- UIS Capability
- This Device is Pb–Free, Halogen Free/BFR Free and is RoHS Compliant

Applications

- PowerTrain Management
- Solenoid and Motor Drivers
- Integrated Starter/Alternator
- Primary Switch for 12 V Systems

MOSFET MAXIMUM RATINGS (T_J = 25° C unless otherwise noted)

Symbol	Parameter	Parameter Ratings	
VDSS	Drain-to-Source Voltage	80	V
Vgs	Gate-to-Source Voltage	±20	V
۱ _D	$ Drain Current - Continuous (V_{GS} = 10) \\ (Note 1) T_C = 25^\circ C $	100	A
	Pulsed Drain Current $T_C = 25^{\circ}C$	See Figure 4	
EAS	Single Pulse Avalanche Energy (Note 2)	82	mJ
PD	Power Dissipation	227	W
	Derate Above 25°C	1.52	W/°C
T _J , T _{STG}	Operating and Storage Temperature	–55 to + 175	°C
$R_{\theta JC}$	Thermal Resistance, Junction to Case	0.66	°C/W
R _{θJA}	Maximum Thermal Resistance, Junction to Ambient (Note 3)	52	°C/W

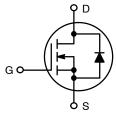
Stresses exceeding those listed in the Maximum Ratings table may damage the device. If any of these limits are exceeded, device functionality should not be assumed, damage may occur and reliability may be affected.

- 1. Current is limited by bondwire configuration.
- Starting T_J = 25°C, L = 40 μH, I_{AS} = 64 A, V_{DD} = 80 V during inductor charging and V_{DD} = 0V during time in avalanche.
 R_{θJA} is the sum of the junction-to-case and case-to-ambient thermal
- 3. R_{0JA} is the sum of the junction-to-case and case-to-ambient thermal resistance, where the case thermal reference is defined as the solder mounting surface of the drain pins. R_{qJC} is guaranteed by design, while R_{0JA} is determined by the board design. The maximum rating presented here is based on mounting on a 1 in² pad of 2oz copper.

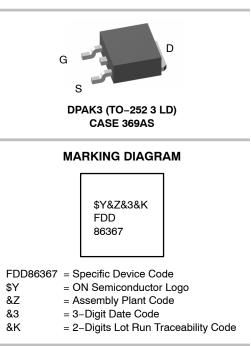


ON Semiconductor®

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ORDERING INFORMATION

See detailed ordering and shipping information on page 2 of this data sheet.

PACKAGE MARKING AND ORDERING INFORMATION

Device	Device Marking	Package	Reel Size	Tape Width	Shipping [†]
FDD86367	FDD86367	DPAK3 (TO-252 3 LD) (Pb-Free)	13"	16 mm	2500 / Tape & Reel

+For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specifications Brochure, BRD8011/D.

ELECTRICAL CHARACTERISTICS (T_J = 25° C unless otherwise noted)

Symbol	Parameter	Condition		Min	Тур	Max	Unit
OFF CHA	RACTERISTICS						
B _{VDSS}	Drain-to-Source Breakdown Voltage	$I_D = 250 \ \mu A, \ V_{GS} = 0 \ V$		80	-	-	V
I _{DSS}	Drain-to-Source Leakage Current	V _{DS} = 80 V, V _{GS} = 0 V	$T_J = 25^{\circ}C$	-	-	1	mA
			T _J = 175°C (Note 4)	-	-	1	mA
I _{GSS}	Gate-to-Source Leakage Current	V _{GS} = ±20 V		-	-	±100	nA
ON CHAR	ACTERISTICS						
V _{GS(th)}	Gate to Source Threshold Voltage	$V_{GS} = V_{DS}, I_D = 250 \ \mu A$		2	3	4	V
R _{DS(on)}	Drain to Source On Resistance	I _D = 80 A, V _{GS} = 10 V	$T_J = 25^{\circ}C$	-	3.3	4.2	mΩ
			T _J = 175°C (Note 4)	_	6.6	8.4	mΩ
DYNAMIC	CHARACTERISTICS	-					-
C _{iss}	Input Capacitance	V _{DS} = 40 V, V _{GS} = 0 V, f = 1 MHz		-	4840	-	pF
C _{oss}	Output Capacitance			-	814	-	pF
C _{rss}	Reverse Transfer Capacitance			-	31	-	pF
Rg	Gate Resistance	V _{GS} = 0.5 V, f = 1 MHz		-	2.3	-	Ω
Q _{g(ToT)}	Total Gate Charge	V_{GS} = 0 to 10 V	$V_{DD} = 40 V$,	-	68	88	nC
Q _{g(th)}	Threshold Gate Charge	V_{GS} = 0 to 2 V	I _D = 80 A	-	8.8	-	nC
Q _{gs}	Gate-to-Source Gate Charge	V _{DD} = 40 V, I _D = 80 A		-	22	-	nC
Q _{gd}	Gate-to-Drain "Miller" Charge			-	14	-	nC
SWITCHIN	NG CHARACTERISTICS	•			•	-	•
t _{on}	Turn-On Time	$V_{DD} = 40 \text{ V}, \text{ I}_{D} = 80 \text{ A}, \text{ V}_{GS} = 10 \text{ V},$ $R_{GEN} = 6 \Omega$		-	-	104	ns
					+	+	———

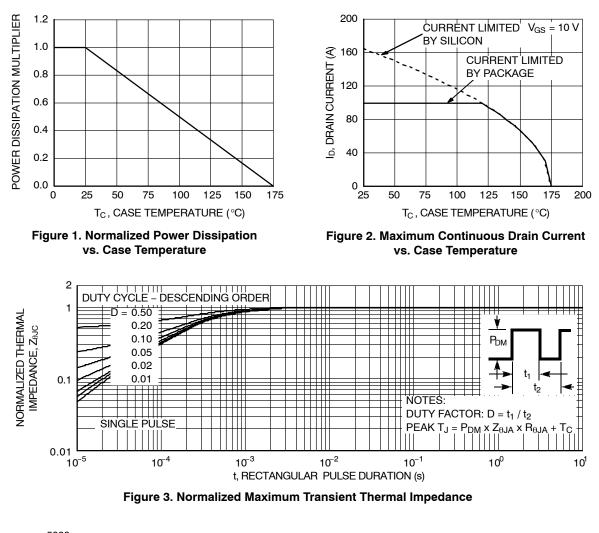
t _{on}	Turn-On Time	$V_{DD} = 40 \text{ V}, \text{ I}_{D} = 80 \text{ A}, \text{ V}_{GS} = 10 \text{ V},$	-	-	104	ns
t _{d(on)}	Turn-On Delay	$R_{GEN} = 6 \Omega$	-	20	-	ns
t _r	Rise Time		-	49	_	ns
t _{d(off)}	Turn-Off Delay		-	36	_	ns
t _f	Fall Time		-	16	_	ns
t _{off}	Turn-Off Time		-	-	80	ns

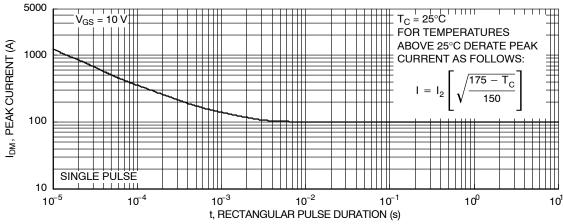
DRAIN-SOURCE DIODE CHARACTERISTICS

V _{SD}	Source-to-Drain Diode Voltage	$I_{SD} = 80 \text{ A}, V_{GS} = 0 \text{ V}$	-	-	1.3	V
		$I_{SD} = 40 \text{ A}, V_{GS} = 0 \text{ V}$	-	-	1.2	V
t _{rr}	Reverse-Recovery Time	V_{DD} = 64 V, I_F = 80 A, dI_{SD}/dt = 100 A/ $\!\mu s$	-	68	102	ns
Q _{rr}	Reverse-Recovery Charge		-	66	106	nC

Product parametric performance is indicated in the Electrical Characteristics for the listed test conditions, unless otherwise noted. Product performance may not be indicated by the Electrical Characteristics if operated under different conditions. 4. The maximum value is specified by design at $T_J = 175^{\circ}$ C. Product is not tested to this condition in production.

TYPICAL CHARACTERISTICS







TYPICAL CHARACTERISTICS (continued)

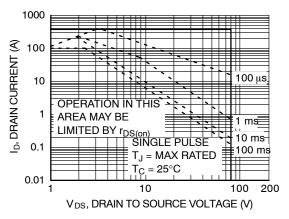
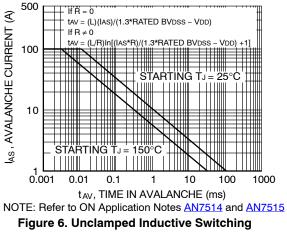
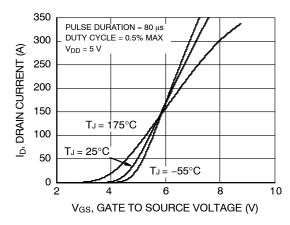
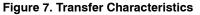


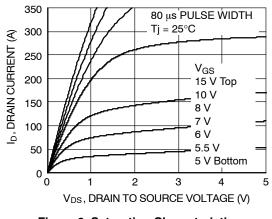
Figure 5. Forward Bias Safe Operating Area



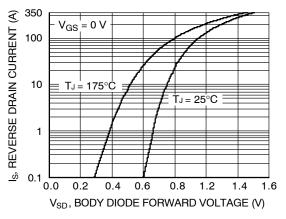
Capability



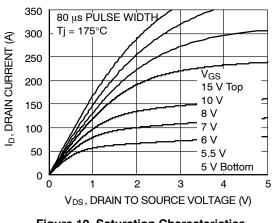






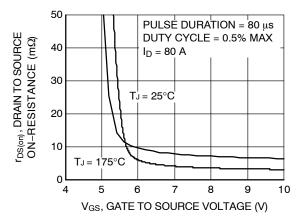


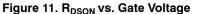






TYPICAL CHARACTERISTICS (continued)





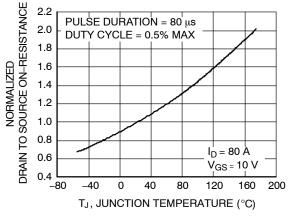


Figure 12. Normalized RDSON vs. Junction Temperature

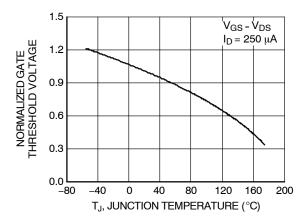


Figure 13. Normalized Gate Threshold Voltage vs. Temperature

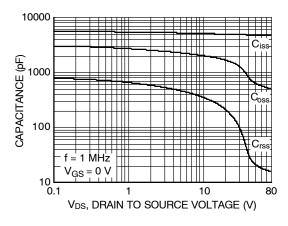


Figure 15. Capacitance vs. Drain to Source Voltage

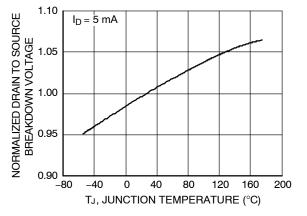


Figure 14. Normalized Drain to Source Breakdown Voltage vs. Junction Temperature

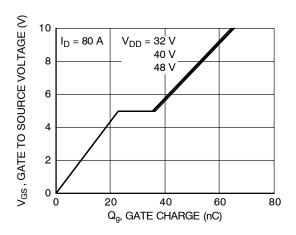
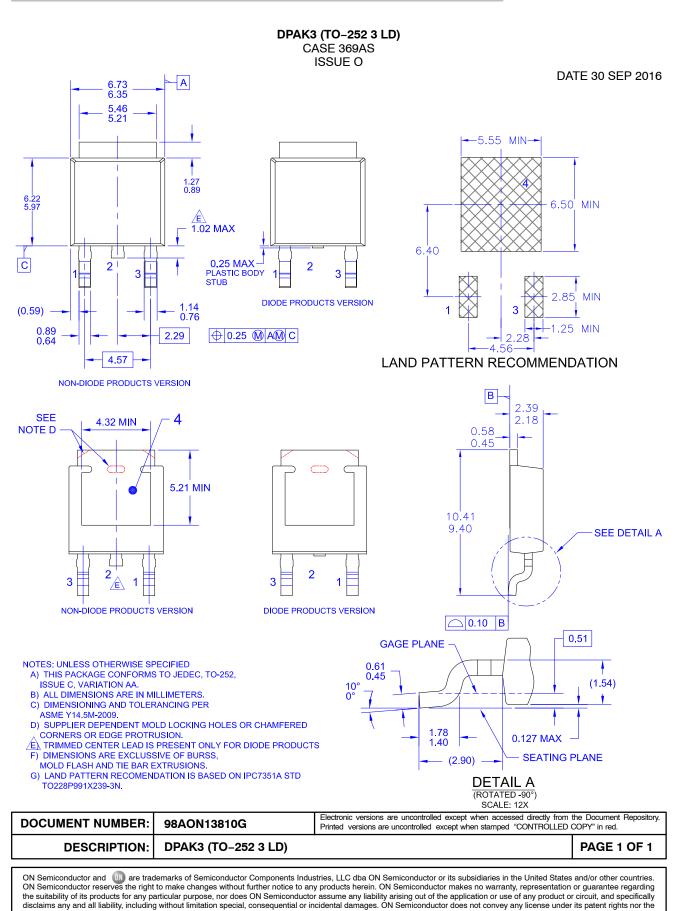


Figure 16. Gate Charge vs. Gate to Source Voltage

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